(TSMC2003-0542)

To Be Determined



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In re application of:

Wen Chin Lin, et al.

Serial No.: 10/827,079

Filed:

April 19, 2004

For:

Non-Orthogonal Write Line

Structure in MRAM

99999999

Art Unit:

Conf. No.:

Examiner:

1883

2818

Docket Number: 24061.90

Commissioner of Patents P.O. Box 1450 Alexandria, VA 22313-1450

SUPPLEMENTAL SHEET TO POWER OF ATTORNEY

In accordance with 37 CFR 1.32 (c)(3) and with reference to the accompanying Power of Attorney, please recognize the following ten patent practitioners as being of record in this application.

Name	Registration Number	
David M. O'Dell	42,044	
Jeffrey M. Becker	35,442	
Timothy F. Bliss	50.925	
Andrew S. Ehmke	50,271	
Dave R. Hofman	55,272	
Wei Wei Jeang	33,305	
Julie M. Nickols	50,826	
J. Andrew Lowes	40,706	
T. Murray Smith	30,222	
Chien Wei Chou	41,672	

Respectfully submitted,

David M. O'Dell

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Dated: 17-04

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8-18-04

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Date

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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

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In re application of:

Lin, et al.

Serial No.: Unknown

Customer No. 27683

Filed: Herewith

For: NON-ORTHOGONAL WRITE LINE

Group Art Unit: Unknown

Attorney Docket No.:

24061.90

TSMC2003-0542

NON-ORTHOGONAL WRITE LINE STRUCTURE IN MRAM Examiner: Unknown

Commissioner for Patents P. O. Box 1450 Alexandria, VA 22313-1450

POWER OF ATTORNEY FOR PATENT APPLICATION

As a representative of the Assignee, Taiwan Semiconductor Manufacturing Company, Ltd., I hereby appoint the following attorneys and/or agents to prosecute this application and transact all business in the Patent and Trademark Office connected therewith.

David L. McCombs (Reg. No. 32,271); Jeffrey M. Becker (Reg. No. 35,442); James R. Bell (Reg. No. 26,528); Timothy F. Bliss (Reg. No. 50,925); Randall C. Brown (Reg. No. 31,213); Randall E. Colson (Reg. No. 40,566); Michael A. Davis, Jr. (Reg. No. 35,488); Andrew S. Ehmke (Reg. No. 50,271); Priscilla Ferguson (Reg. No. 42,531); Sarah T. Harris (Reg. No. 35,891); William E. Hickman (Reg. No. 46,771); David R. Hofman (Reg. No. P-55,727); Rita M. Irani (Reg. No. 31,028); Wei Wei Jeang (Reg. No. 33,305; Warren B. Kice (Reg. No. 22,732); J. Andrew Lowes (Reg. No. 40,706); Todd Mattingly (Reg. No. 40,298); Julie Nickols (Reg. No. 50,826); Gloria Norberg (Reg. No. 36,706); David M. O'Dell (Reg. No. 42,044); T. Murray Smith (Reg. No. 30,222); and Chien Wei Chou (Reg. No. 41,672).

Please address all correspondence and telephone calls regarding this application to:

David M. O'Dell Attorney for Applicants Haynes and Boone, LLP 901 Main Street, Suite 3100 Dallas, TX 75202-3789 972-739-8635 / 214-200-0853 - Fax

The undersigned is the representative for the Assignee of the entire right, title, and interest in the patent application identified above. A copy of the assignment or other documents in the chain of title are attached.

The undersigned (whose title is supplied below) is authorized to act on behalf of the Assignee.

Taiwan Semiconductor Manufacturing Company, Ltd.

est

Date

Chien-Wei Chou

Title: Director, IP Division



ASSIGNMENT

WHEREAS, we,

Was Chia Lin

(1)	wen Chin Lin	01	Hsin-Chu, Taiwan, R.O.C.
(2)	Denny Tang	of	Saratoga, CA, USA
(3)	Li-Shyue Lai	of	Jhube City, Hsin Chu, Taiwan, R.O.C.

have invented certain improvements in

NON-ORTHOGONAL WRITE LINE STRUCTURE IN MRAM

for which we have executed an application for Letters Patent of the United States of America, filed April 19, 2004 and assigned application no. 10/827,079.

WHEREAS, we authorize the attorney of record to update this document to include Patent Office information as deemed necessary (i.e., filing date, serial number, etc.);

WHEREAS, Taiwan Semiconductor Manufacturing Company, Ltd., ("TSMC"), No. 8, Li-Hsin Rd. 6, Science-Based Industrial Park Hsin-Chu, Taiwan 300-77, Republic of China. is desirous of obtaining the entire right, title, and interest in, to and under the said invention and the said application in the United States of America and in any and all countries foreign thereto;

NOW, THEREFORE, for One Dollar (\$1.00) and other good and valuable consideration, the receipt and sufficiency of which is hereby acknowledged, and other good and valuable consideration, we have sold, assigned, transferred and set over, and by these presents do hereby sell, assign, transfer and set over, unto the said TSMC, its successors, legal representatives, and assigns, the entire right, title, and interest in, to and under the said invention, and the said application, and all divisional, renewal, substitutional, and continuing applications thereof, and all Letters Patent of the United States of America which may be granted thereon and all reissues and extensions thereof, and all applications for Letters Patent which may be filed for said invention in any country or countries foreign to the United States of America, and all extensions, renewals, and reissues thereof, and all prior patents and patent applications from which a filing priority of the above-described patent application may be obtained, including the right to collect past damages; and we hereby authorize and request the Commissioner of Patents of the United States of America, and any official of any country or countries foreign to the United States of America, whose duty it is to issue patents on applications as aforesaid, to issue all Letters Patent for said invention to the said TSMC, its successors, legal representatives and assigns, in accordance with the terms of this instrument.

AND WE HEREBY covenant that we have full right to convey the entire interest herein assigned, and that we have not executed, and will not execute, any agreement in conflict herewith.

AND WE HEREBY further covenant and agree that we will communicate to said TSMC, its successors, legal representatives and assigns, any facts known to us respecting said invention, and testify in any legal proceedings, sign all lawful papers, execute all divisional, renewal, substitutional, continuing, and reissue applications, make all rightful declarations and/or oaths and generally do everything possible to aid the said TSMC, its successors, legal representatives and assigns, to obtain and enforce proper patent protection for said invention in all countries.

First Inventor Name: Wen Chin Lin Residence Address: 288, 4F-2 Park Road Hsin-Chu, Taiwan, 300, R.O.C. Dated: 2 4/04/26 Second Inventor Name: Denny D. Tang Residence Address: 20407 Cunningham Place Saratoga, CA 95070, USA Third Inventor Name: Li-Shyue Lai Residence Address: 10F, No. 5, Lane 371, Jhong Iheng E., Rd. Jhube City, Hsin Chu, Taiwan, R.O.C. Dated: 2 4 /04/27

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